

Primary-Side Regulation LED Driver Controller with Active-PFC

General Description

The RT7304A is a constant current LED driver with active power factor correction. It supports high power factor across a wide range of line voltages, and it drives the converter in the Quasi-Resonant (QR) mode to achieve higher efficiency. By using Primary Side Regulation (PSR), the RT7304A controls the output current accurately without a shunt regulator and an opto-coupler at the secondary side, reducing the external component count, the cost, and the volume of the driver board.

The RT7304A embeds comprehensive protection functions for robust designs, including LED open-circuit protection, LED short-circuit protection, output diode short-circuit protection, VDD Under-Voltage Lockout (UVLO), VDD Over-Voltage Protection (VDD OVP), Over-Temperature Protection (OTP), and cycle-by-cycle current limitation.

Features

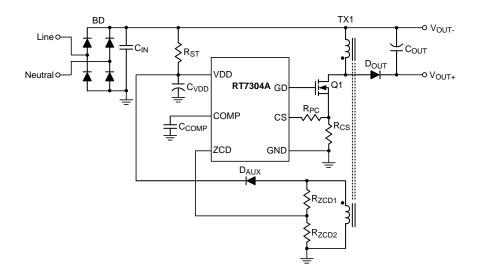
- Tight LED Current Regulation
- No Opto-Coupler and TL431 Required
- Power Factor Correction (PFC)
- Quasi-Resonant
- Maximum/Minimum Switching Frequency Clamping
- Maximum/Minimum on-Time Limitation
- Wide VDD Range (up to 34V)
- THD Optimization
- Input-Voltage Feed-Forward Compensation
- Multiple Protection Features
 - **▶ LED Open-Circuit Protection**
 - **▶ LED Short-Circuit Protection**
 - ▶ Output Diode Short-Circuit Protection
 - ▶ VDD Under-Voltage Lockout
 - ▶ VDD Over-Voltage Protection
 - **▶** Over-Temperature Protection
 - **▶** Cycle-by-Cycle Current Limitation

Applications

AC/DC LED Lighting Driver

Simplified Application Circuit

Buck-Boost Converter

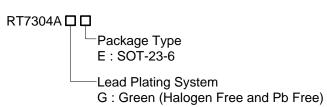


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Ordering Information

Pin Configurations



(TOP VIEW)

COMP ZCD CS

6 5 4

2 3

GND VDD GD

Note:

Richtek products are:

SOT-23-6

- ▶ RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶ Suitable for use in SnPb or Pb-free soldering processes.

Marking Information



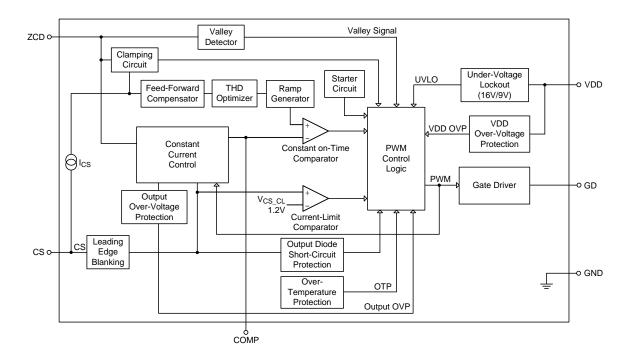
4T=: Product Code DNN: Date Code

Functional Pin Description

Pin No.	Pin Name	Pin Function					
1	GND	Ground of the Controller.					
2	VDD	Supply Voltage (V_{DD}) Input. The controller will be enabled when V_{DD} exceeds V_{TH_ON} and disabled when V_{DD} is lower than V_{TH_OFF} .					
3	GD	Gate Driver Output for External Power MOSFET.					
4	CS	Current Sense Input. Connect this pin to the current sense resistor.					
5	ZCD	Zero Current Detection Input. This pin is used to sense the voltage at auxiliary winding of the transformer.					
6	COMP	Compensation Node. Output of the internal trans-conductance amplifier.					



Function Block Diagram



Operation

Critical-Conduction Mode (CRM) with Constant On-Time Control

Figure 1 shows a typical flyback converter with input voltage (V_{IN}). When main switch Q1 is turned on with a fixed on-time (t_{ON}), the peak current (I_{L_PK}) of the magnetic inductor (L_m) can be calculated by the following equation :

$$I_{L_PK} = \frac{V_{IN}}{L_m} \times t_{ON}$$

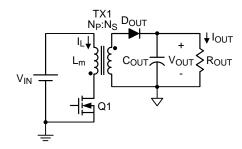


Figure 1. Typical Flyback Converter

If the input voltage is the output voltage of the full-bridge rectifier with sinusoidal input voltage ($V_{IN_PK\cdot sin(\theta)}$), the inductor peak current (I_{L_PK}) can be expressed as the following equation :

$$I_{L_PK} = \frac{V_{IN_PK} \times |sin(\theta)| \times t_{ON}}{L_m}$$

When the converter operates in CRM with constant on-time control, the envelope of the peak inductor current will follow the input voltage waveform with in-phase. Thus, high power factor can be achieved, as shown in Figure 2.

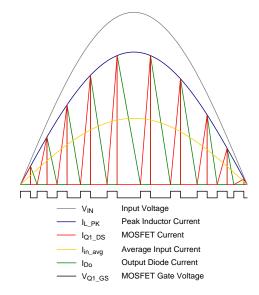


Figure 2. Inductor Current of CRM with Constant
On-Time Control

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RT7304A needs no shunt regulator and opto-coupler at the secondary side to achieve the output current regulation. Figure 3 shows several key waveforms of a conventional flyback converter in Quasi-Resonant (QR) mode, in which V_{AUX} is the voltage on the auxiliary winding of the transformer.

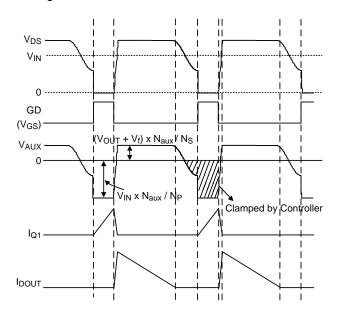


Figure 3. Key Waveforms of a Flyback Converter

Voltage Clamping Circuit

The RT7304A provides a voltage clamping circuit at ZCD pin since the voltage on the auxiliary winding is negative when the main switch is turned on. The lowest voltage on ZCD pin is clamped near zero to prevent the IC from being damaged by the negative voltage. Meanwhile, the sourcing ZCD current (Izcd SH), flowing through the upper resistor (RzcD1), is sampled and held to be a line-voltage-related signal for propagation delay compensation. The RT7304A embeds the programmable propagation compensation through CS pin. A sourcing current Ics (equal to Izcd SH x Kpc) applies a voltage offset (Ics x RPC) which is proportional to line voltage on CS to compensate the propagation delay effect. Thus, the output current can be equal at high and low line voltage.

Quasi-Resonant Operation

Figure 4 illustrates how valley signal triggers PWM. If no valley signal detected for a long time, the next PWM is triggered by a starter circuit at end of the interval (tstart, 130 μ s typ.) which starts at the rising edge of the previous PWM signal. A blanking time (ts(MIN), 8.5 μ s typ.), which starts at the rising edge of the previous PWM signal, limits minimum switching period. When the ts(MIN) interval is on-going, all of valley signals are not allowed to trigger the next PWM signal. After the end of the ts(MIN) interval, the coming valley will trigger the next PWM signal. If one or more valley signals are detected during the ts(MIN) interval and no valley is detected after the end of the ts(MIN) interval, the next PWM signal will be triggered automatically at end of the ts(MIN) + 5 μ s (typ.).

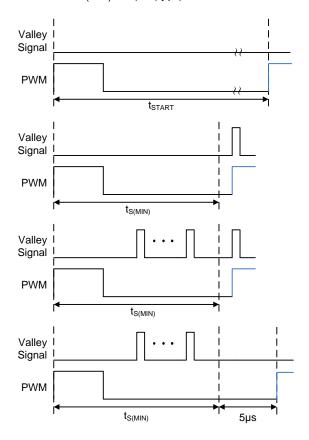


Figure 4. PWM Triggered Method

Protections

LED Open-Circuit Protection

In an event of output open circuit, the converter will be shut down to prevent being damaged, and it will be auto-restarted when the output is recovered. Once the LED is open-circuit, the output voltage keeps rising, causing the voltage on ZCD pin VzcD rising accordingly. When the sample-and-hold ZCD voltage (VzcD_SH)



exceeds its OV threshold (V_{ZCD_OVP}, 3.2V typ.), output OVP will be activated and the PWM output (GD pin) will be forced low to turn off the main switch. If the output is still open-circuit when the converter restarts, the converter will be shut down again.

Output Diode Short-Circuit Protection

When the output diode is damaged as short-circuit, the transformer will be led to magnetic saturation and the main switch will suffer from a high current stress. To avoid the above situation, an output diode short-circuit protection is built-in. When CS voltage Vcs exceeds the threshold (Vcs_sd 1.7 typ.) of the output diode short-circuit protection, RT7304A will shut down the PWM output (GD pin) in few cycles to prevent the converter from damage. It will be auto-restarted when the failure condition is recovered.

VDD Under-Voltage Lockout (UVLO) and Over-Voltage Protection (VDD OVP)

RT7304A will be enabled when VDD voltage (V_{DD}) exceeds rising UVLO threshold (V_{TH_ON} , 17V typ.) and disabled when V_{DD} is lower than falling UVLO threshold (V_{TH_OFF} , 8.5V typ.).

When V_{DD} exceeds its over-voltage threshold (V_{OVP} , 37.4V typ.), the PWM output of RT7304A is shut down. It will be auto-restarted when the VDD is recovered to a normal level.

Over-Temperature Protection (OTP)

The RT7304A provides an internal OTP function to protect the controller itself from suffering thermal stress and permanent damage. It's not suggested to use the function as precise control of over temperature. Once the junction temperature is higher than the OTP threshold (TsD, 150°C typ.), the controller will shut down until the temperature cools down by 30°C (typ.). Meanwhile, if VDD reaches falling UVLO threshold voltage (VTH_OFF), the controller will hiccup till the over temperature condition is removed.



Absolute	Maximum	Ratings	(Note 1)
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• Supply Voltage, V _{DD}	0.3V to 40V
Gate Driver Output, GD	0.3V to 20V
• Other Pins	0.3V to 6V
 Power Dissipation, P_D @ T_A = 25°C 	
SOT-23-6	0.42W
Package Thermal Resistance (Note 2)	
SOT-23-6, θJA	235.6°C/W
Lead Temperature (Soldering, 10 sec.)	260°C
Junction Temperature	150°C
Storage Temperature Range	65°C to 150°C
• ESD Susceptibility (Note 3)	
HBM (Human Body Model)	2kV
MM (Machine Model)	200V

(Note 4)

Electrical Characteristics

 $(V_{DD} = 15V, T_A = 25^{\circ}C, unless otherwise specified)$

Recommended Operating Conditions

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
VDD Section							
VDD OVP Threshold Voltage	Vovp	V _{DD} Rising	35.4	37.4	39.4	V	
Rising UVLO Threshold Voltage	V _{TH} ON		16	17	18	V	
Falling UVLO Threshold Voltage	V _{TH_OFF}		7.5	8.5	9.5	V	
Operating Current	I _{DD_OP}	$V_{DD} = 15V$, $I_{ZCD} = 0$, GD open		2	3	mΑ	
Start-up Current	I _{VDD_ST}	V _{DD} = V _{TH_ON} - 1V		15	30	μΑ	
ZCD Section	ZCD Section						
Lower Clamp Voltage	Vzcol	I _{ZCD} = 0 to -2.5mA	-50	0	60	mV	
ZCD OVP Threshold Voltage	V _{ZCD_OVP}		3.04	3.2	3.36	V	
Constant Current Control Secti	Constant Current Control Section						
Maximum Regulated factor for constant-current control	K _{CC(MAX)}	V _{DIM} = 3V	246.25	250	253.75	mV	
Maximum Comp Voltage	VCOMP(MAX)		5	5.5		V	
Minimum Comp Voltage	V _{COMP} (MIN)			0.5		V	
Maximum Sourcing Current	ICOMP(MAX)	During start-up period		100		μΑ	
Current Sense Section							
Leading Edge Blanking Time	tleb		240	400	570	ns	

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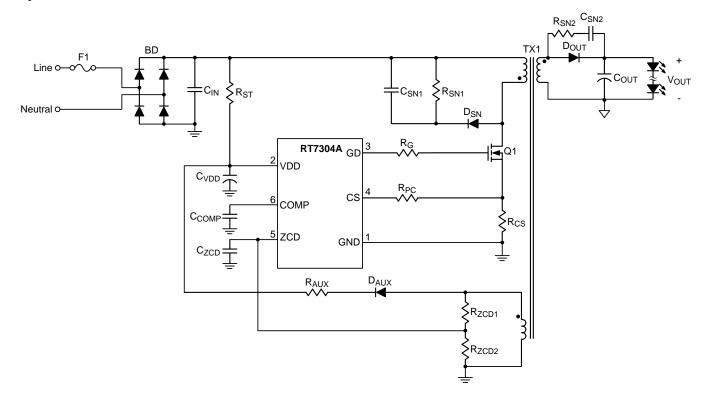
Parameter	Parameter Symbol Test Conditions		Min	Тур	Max	Unit
Peak Current Shutdown Voltage Threshold	Vcs_sd		1.53	1.7	1.87	V
Peak Current Limitation at Normal Operation	Vcs_cl		1.08	1.2	1.32	V
Propagation Delay Compensation Factor	K _{PC}	I _{CS} = K _{PC} x I _{ZCD} , I _{ZCD} = -150μA		0.042		A/A
Gate Driver Section						
Rising Time	t _R	V _{DD} = 15V, C _L = 1nF		140	250	ns
Falling Time	t _F	V _{DD} = 15V, C _L = 1nF		40	70	ns
Gate Output Clamping Voltage	VCLAMP	V _{DD} = 15V, C _L = 1nF	10.8	12	13.2	V
Timing Control Section	Timing Control Section					
Minimum on-Time	ton(MIN)	$I_{ZCD} = -150\mu A$	0.9	1.25	1.6	μS
Minimum Switching Period	ts(MIN)		7	8.5	10	μS
Duration of Starter at Normal Operation	tSTART		75	130	300	μS
Maximum on-Time	ton(MAX)		29	47	65	μS
Over-Temperature Protection (OTP) Section						
OTP Temperature Threshold	TOTP	(Note 5)		150		°C
OTP Temperature Hysteresis	Totp-HYS	(Note 5)		30		°C

- **Note 1.** Stresses beyond those listed "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
- Note 2. θ_{JA} is measured under natural convection (still air) at $T_A = 25^{\circ}\text{C}$ with the component mounted on a low effective-thermal-conductivity two-layer test board on a JEDEC thermal measurement standard.
- Note 3. Devices are ESD sensitive. Handling precaution recommended.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- Note 5. Guarantee by design.

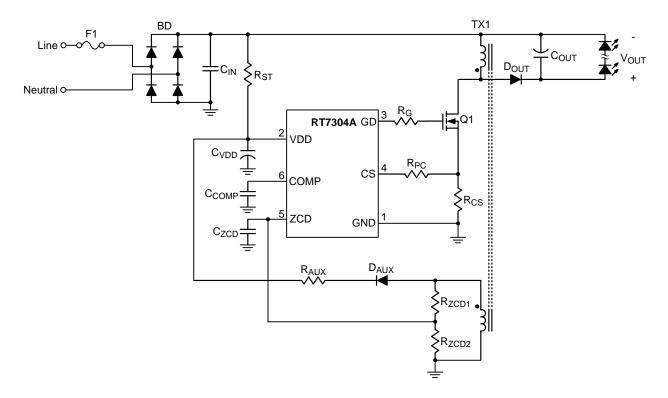


Typical Application Circuit

Flyback Converter

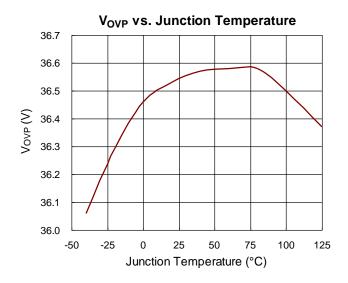


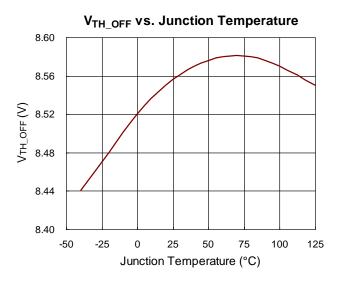
Buck-Boost Converter

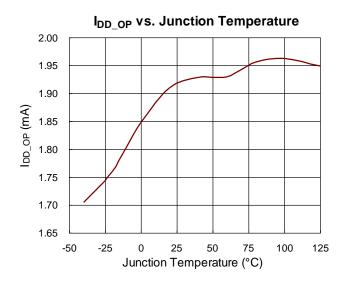


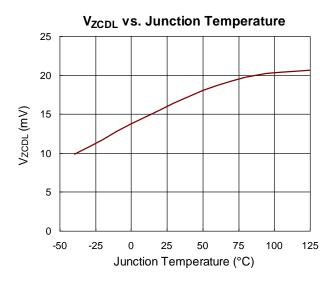


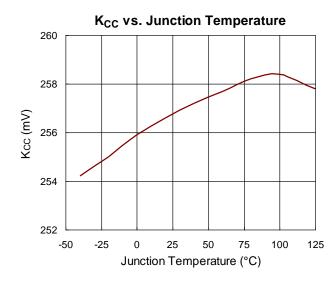
Typical Operating Characteristics

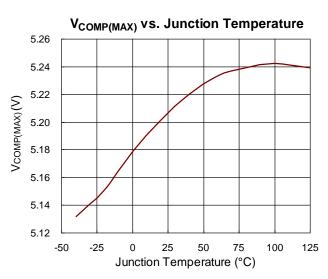






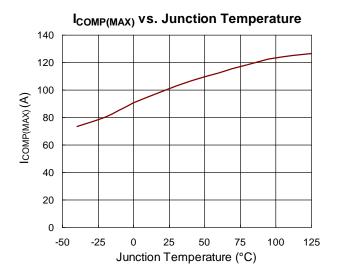


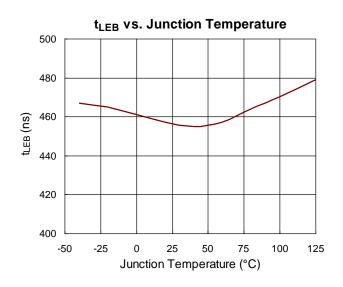


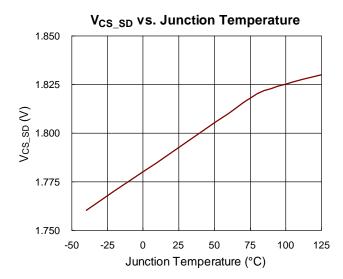


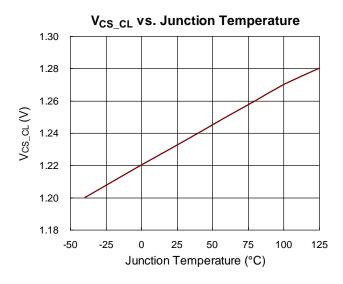
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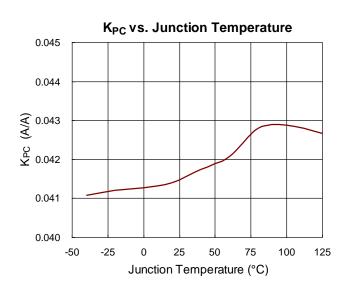


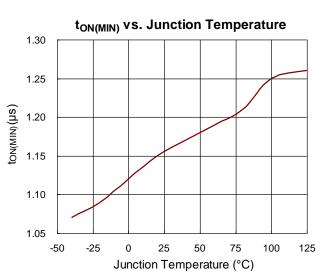


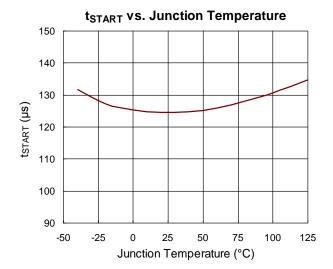


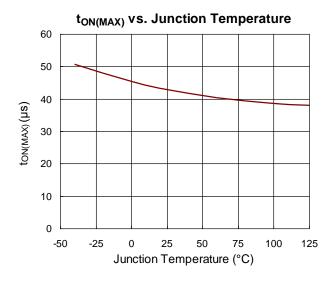














Application Information

Output Current Setting

Considering the conversion efficiency, the programmed DC level of the average output current ($I_{OUT}(t)$) can be derived as :

$$I_{OUT_CC} = \frac{1}{2} \times \frac{NP}{NS} \times \frac{KCC}{RCS} \times CTR_{TX1}$$

$$CTR_{TX1} = \frac{I_{SEC_PK}}{I_{PRI_PK}} \times \frac{N_S}{N_P}$$

in which CTR_{TX1} is the current transfer ratio of the transformer TX1, I_{SEC_PK} is the peak current of the secondary side, and I_{PRI_PK} is the peak current of the primary side. CTR_{TX1} can be estimated to be 0.9. According to the above parameters, current sense resistor R_{CS} can be determined as the following equation:

$$RCS = \frac{1}{2} \times \frac{NP}{NS} \times \frac{KCC}{I_{OUT} CC} \times CTR_{TX1}$$

Propagation Delay Compensation Design

The V_{CS} deviation (ΔV_{CS}) caused by propagation delay effect can be derived as:

$$\Delta V_{CS} = \frac{V_{IN} \cdot t_D \cdot R_{CS}}{L_m} \; , \label{eq:deltaVCS}$$

in which t_D is the delay period which includes the propagation delay of RT7304A and the turn-off transition of the main MOSFET. The sourcing current from CS pin of RT7304A (I_{CS}) can be expressed as :

$$I_{CS} = K_{PC} \cdot V_{IN} \cdot \frac{N_A}{N_P} \cdot \frac{1}{R_{ZCD1}}$$

where N_A is the turns number of the auxiliary winding. R_{PC} can be designed by :

$$R_{PC} = \frac{\Delta V_{CS}}{I_{CS}} = \frac{t_D \cdot R_{CS} \cdot R_{ZCD1}}{L_m \cdot K_{PC}} \cdot \frac{N_P}{N_A}$$

Feed-Forward Compensation Design

The COMP voltage, V_{COMP}, is a function of the resistor R_{ZCD1} as following:

$$R_{ZCD1} = \left(V_{IN_pk} \times \frac{N_A}{N_P} \times K_{IV}\right) \times \sqrt{\frac{\left(\frac{t_{ON}}{t_S}\right) \times Gm_{ramp} \times t_{ON}}{2 \times C_{ramp} \times \left(V_{COMP} - V_D\right)}}$$

in which K_{IV} , Gm_{ramp} , and C_{ramp} are fixed parameters in the RT7304A, and the typical value are : $K_{IV} = 2.5 \text{V/mA}$, $Gm_{ramp} = 8\mu\text{A/V}$, $C_{ramp} = 6.5 \text{pF}$.

 V_D is the offset of the constant on-time comparator, and its typical value is 0.63V. It is recommended to design $V_{COMP}=2$ to 3V. If the COMP voltage is over its recommended operating range (0.7 to 4.3V), output current regulation may be affected. Thus, the resistors R_{ZCD1} can be determined according to the above parameters.

Minimum On-Time Setting

The RT7304A limits a minimum on-time ($t_{ON(MIN)}$) for each switching cycle. The $t_{ON(MIN)}$ can be derived from the following equations.

$$tON(MIN) \times I_{ZCD}$$
 SH = 187.5p·sec·A (typ.)

Thus, RzcD1 can be determined by:

$$R_{ZCD1} = \frac{t_{ON(MIN)} \times V_{IN}}{187.5p} \times \frac{N_A}{N_P} \text{ (typ.)}$$

In addition, the current flowing out of ZCD pin must be lower than 2.5mA (typ.). Thus, the R_{ZCD1} is also determined by :

$$R_{ZCD1} > \frac{\sqrt{2} \cdot V_{AC(MAX)}}{2.5m} \times \frac{N_A}{N_P}$$

where the V_{AC(MAX)} is maximum input AC voltage.

Output Over-Voltage Protection Setting

Output OVP is achieved by sensing the voltage on the auxiliary winging. It is recommended that output OV level (Vout_ovP) is set at 120% of nominal output voltage (Vout). Thus, RzcD1 and RzcD2 can be determined by the equation as:

$$V_{OUT} \times \frac{N_A}{N_S} \times \frac{R_{ZCD2}}{R_{ZCD1} + R_{ZCD2}} \times 120\% = 3.2 V(typ.)$$



Thermal Considerations

For continuous operation, do not exceed absolute maximum junction temperature. The maximum power dissipation depends on the thermal resistance of the IC package, PCB layout, rate of surrounding airflow, and difference between junction and ambient temperature. The maximum power dissipation can be calculated by the following formula:

 $P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$

Where $T_{J(MAX)}$ is the maximum junction temperature, T_A is the ambient temperature, and θ_{JA} is the junction to ambient thermal resistance.

For recommended operating condition specifications, the maximum junction temperature is 125°C. The junction to ambient thermal resistance, θ_{JA} , is layout dependent. For SOT-23-6 packages, the thermal resistance, θ_{JA} , is 235.6°C/W on a standard JEDEC 51-3 two-layer thermal test board.The maximum power dissipation at T_{A} = 25°C can be calculated by the following formula:

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / (235.6^{\circ}C/W) = 0.42W$ for SOT-23-6 package.

The maximum power dissipation depends on the operating ambient temperature for fixed $T_{J(MAX)}$ and thermal resistance, θ_{JA} . The derating curve in Figure 5 allows the designer to see the effect of rising ambient temperature on the maximum power dissipation.

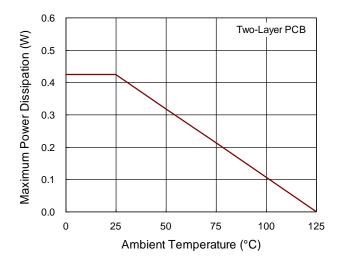


Figure 5. Derating Curve of Maximum Power

Dissipation

Layout Considerations

A proper PCB layout can abate unknown noise interference and EMI issue in the switching power supply. Please refer to the guidelines when designing a PCB layout for switching power supply:

- ▶ The current path(1) from input capacitor, transformer, MOSFET, R_{CS} return to input capacitor is a high frequency current loop. The path(2) from GD pin, MOSFET, R_{CS} return to the ground of the IC is also a high frequency current loop. They must be as short as possible to decrease noise coupling and kept a space to other low voltage traces, such as IC control circuit paths, especially. Besides, the path(3) between MOSFET ground(b) and IC ground(d) is recommended to be as short as possible, too.
- ► The path(4) from RCD snubber circuit to MOSFET is a high switching loop. Keep it as small as possible.
- ▶ It is good for reducing noise, output ripple and EMI issue to separate ground traces of input capacitor(a), MOSFET(b), auxiliary winding(c) and IC control circuit(d). Finally, connect them together on input capacitor ground(a). The areas of these ground traces should be kept large.
- ▶ To minimize parasitic trace inductance and EMI, minimize the area of the loop connecting the secondary winding, the output diode, and the output filter capacitor. In addition, apply sufficient copper area at the anode and cathode terminal of the diode for heat-sinking. It is recommended to apply a larger area at the quiet cathode terminal. A large anode area will induce high-frequency radiated EMI.

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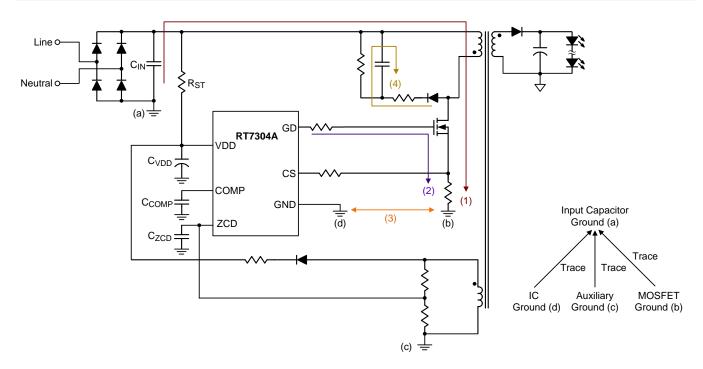
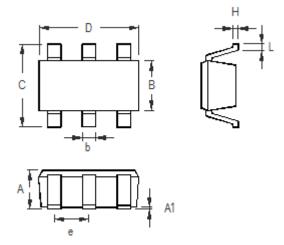


Figure 6. PCB Layout Guide



Outline Dimension

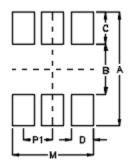


Symbol	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min	Max	Min	Max	
А	0.889	1.295	0.031	0.051	
A1	0.000	0.152	0.000	0.006	
В	1.397	1.803	0.055	0.071	
b	0.250	0.560	0.010	0.022	
С	2.591	2.997	0.102	0.118	
D	2.692	3.099	0.106	0.122	
е	0.838	1.041	0.033	0.041	
Н	0.080	0.254	0.003	0.010	
L	0.300	0.610	0.012	0.024	

SOT-23-6 Surface Mount Package



Footprint Information



	Number of	Footprint Dimension (mm)					Talaranaa	
Package	Pin	P1	Α	В	С	D	М	Tolerance
TSOT-26/TSOT-26(FC)/SOT-26	6	0.95	3.60	1.60	1.00	0.70	2.60	±0.10

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EVB_RT7235GQW EVB_RT7237AHGSP EVB_RT7251AZQW RT5047AGSP EVB_RT7272AGSP EVB_RT7237CHGSP

EVB_RT7247AHGSP EVB_RT7252BZSP EVB_RT7280GQW EVB_RT8292AHZSP EVB_RT8297BZQW EVB_RT7231GQW

EVB_RT7232GQW EVB_RT7236GQW EVB_RT7250BZSP EVB_RT7251BZQW EVB_RT7279GQW EVB_RT8008GB RT8207MZQW

RT8296AHZSP RT9011-JGPJ6 RT8258GE RT5711AHGQW RT9081AGQZA(2) RT6154BGQW RT7238BGQUF RT5788AGJ8F

RT8812AGQW RT6278BHGQUF RT7270HZSP RD0004 RT5789AGQUF RT9076-18GVN RT9193-15GU5 RT3602AJGQW

RT8296BHZSP RT6214AHGJ6F RT9276GQW(Z00)